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**Features**

- Typ  $r_{DS(on)}$  = 171mΩ at  $V_{GS} = 10V$ ,  $I_D = 20A$
- Typ  $Q_g(tot)$  = 78nC at  $V_{GS} = 10V$ ,  $I_D = 20A$
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

**Description**

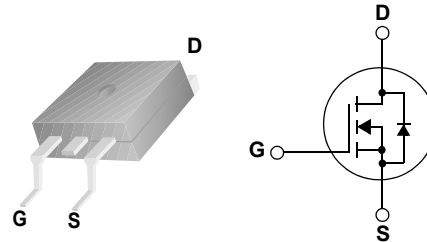
SuperFET™ is Fairchild's proprietary new generation of high voltage MOSFETs utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy.

Consequently, SuperFET is suitable for various automotive DC/DC power conversion.

**Applications**

- Automotive On Board Charger
- Automotive DC/DC converter for HEV



For current package drawing, please refer to the Fairchild website at [www.fairchildsemi.com/packaging](http://www.fairchildsemi.com/packaging)



**MOSFET Maximum Ratings**  $T_J = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{DSS}$	Drain to Source Voltage	600	V
$V_{GS}$	Gate to Source Voltage	±30	V
$I_D$	Drain Current - Continuous ( $V_{GS}=10$ ) (Note 1)	$T_C = 25^\circ\text{C}$	20
	Pulsed Drain Current	$T_C = 25^\circ\text{C}$	See Figure4
$E_{AS}$	Single Pulse Avalanche Energy (Note 2)	217.8	mJ
$P_D$	Power Dissipation	405	W
	Derate above $25^\circ\text{C}$	2.7	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Temperature	-55 to + 150	$^\circ\text{C}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	0.37	$^\circ\text{C/W}$
$R_{\theta JA}$	Maximum Thermal Resistance Junction to Ambient (Note 3)	43	$^\circ\text{C/W}$

**Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCB20N60F	FCB20N60F_F085	TO-263AB	330mm	24mm	800 units

Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting  $T_J = 25^\circ\text{C}$ ,  $L = 10\text{mH}$ ,  $I_{AS} = 6.6\text{A}$ ,  $V_{DD} = 100\text{V}$  during inductor charging and  $V_{DD} = 0\text{V}$  during time in avalanche
- 3:  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

**Electrical Characteristics**  $T_J = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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**Off Characteristics**

$V_{VDSS}$	Drain to Source Breakdown Voltage	$I_D = 250\mu\text{A}$ , $V_{GS} = 0\text{V}$	600	-	-	V
$I_{DSS}$	Drain to Source Leakage Current	$V_{DS} = 600\text{V}$ , $T_J = 25^\circ\text{C}$	-	-	10	$\mu\text{A}$
		$V_{GS} = 0\text{V}$ , $T_J = 150^\circ\text{C}$ (Note 4)	-	-	500	$\mu\text{A}$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS} = \pm 30\text{V}$	-	-	$\pm 100$	nA

**On Characteristics**

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250\mu\text{A}$	3.0	4.3	5.0	V
$r_{DS(on)}$	Drain to Source On Resistance	$I_D = 20\text{A}$ , $T_J = 25^\circ\text{C}$	-	171	195	$\text{m}\Omega$
		$V_{GS} = 10\text{V}$ , $T_J = 150^\circ\text{C}$ (Note 4)	-	444	511	$\text{m}\Omega$

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{V}$ , $V_{GS} = 0\text{V}$ , $f = 1\text{MHz}$	-	2305	-	pF
$C_{oss}$	Output Capacitance		-	1310	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	105	-	pF
$R_g$	Gate Resistance	$f = 1\text{MHz}$	-	0.95	-	$\Omega$
$Q_{g(ToT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V	-	78	102	nC
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 0$ to 2V				
$Q_{gs}$	Gate to Source Gate Charge					
$Q_{gd}$	Gate to Drain "Miller" Charge		-	41.5	-	nC

**Switching Characteristics**

$t_{on}$	Turn-On Time	$V_{DD} = 300\text{V}$ , $I_D = 20\text{A}$ , $V_{GS} = 10\text{V}$ , $R_G = 25\Omega$	-	-	176	ns
$t_{d(on)}$	Turn-On Delay Time		-	43	-	ns
$t_r$	Rise Time		-	66	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	211	-	ns
$t_f$	Fall Time		-	42	-	ns
$t_{off}$	Turn-Off Time		-	-	403	ns

**Drain-Source Diode Characteristics**

$V_{SD}$	Source to Drain Diode Voltage	$I_{SD} = 20\text{A}$ , $V_{GS} = 0\text{V}$	-	-	1.4	V
$T_{rr}$	Reverse Recovery Time	$I_F = 20\text{A}$ , $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	163	-	ns
$Q_{rr}$	Reverse Recovery Charge	$V_{DD} = 480\text{V}$	-	1285	-	nC

**Notes:**

4: The maximum value is specified by design at  $T_J = 150^\circ\text{C}$ . Product is not tested to this condition in production.

### Typical Characteristics

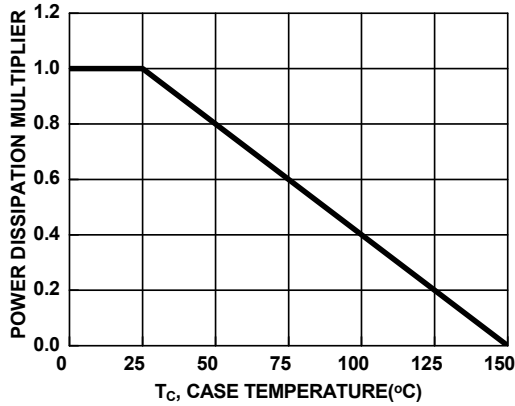


Figure 1. Normalized Power Dissipation vs Case Temperature

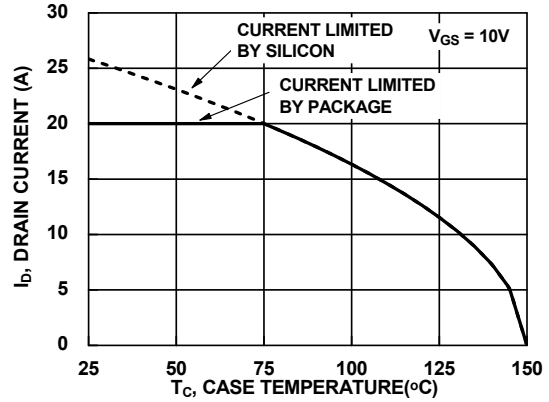


Figure 2. Maximum Continuous Drain Current vs Case Temperature

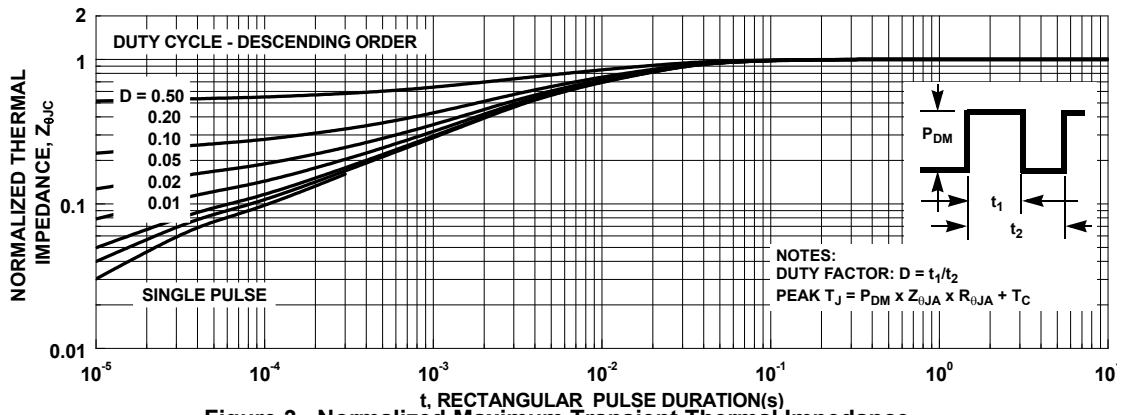


Figure 3. Normalized Maximum Transient Thermal Impedance

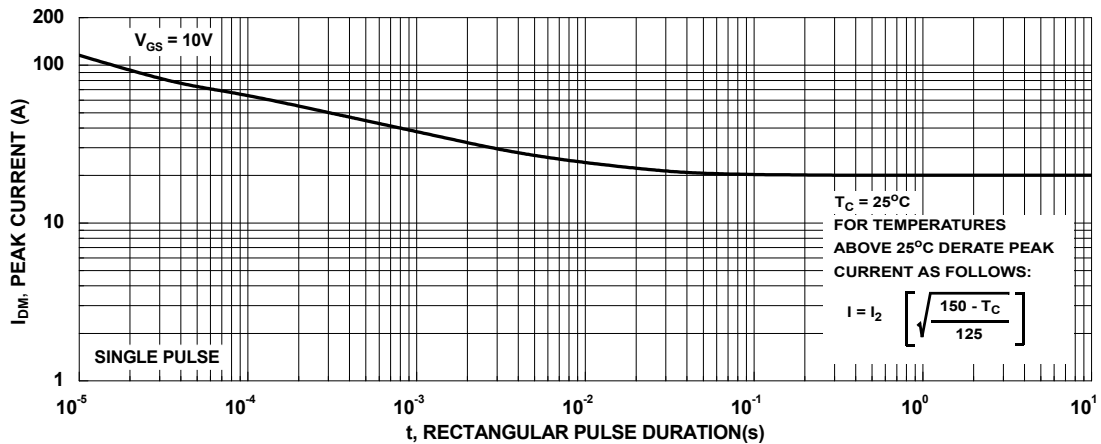


Figure 4. Peak Current Capability

## Typical Characteristics

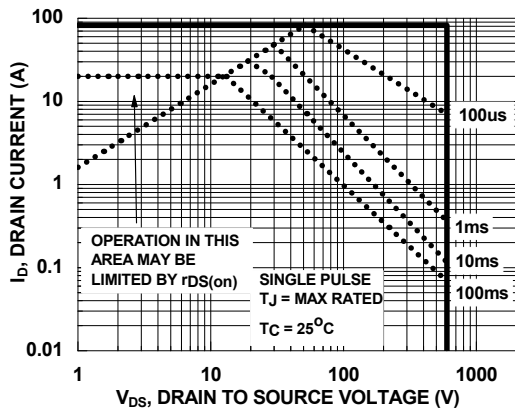


Figure 5. Forward Bias Safe Operating Area

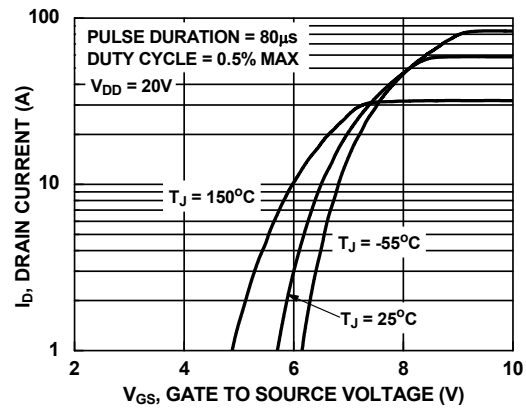


Figure 6. Transfer Characteristics

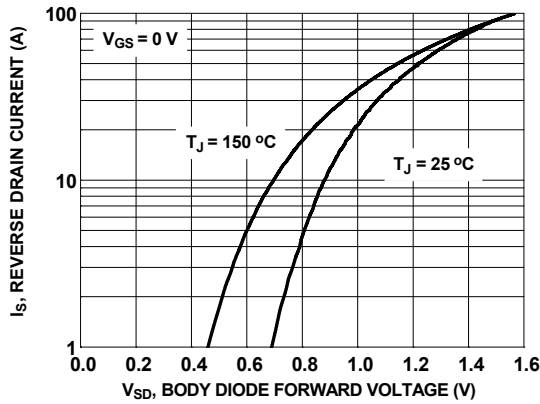


Figure 7. Forward Diode Characteristics

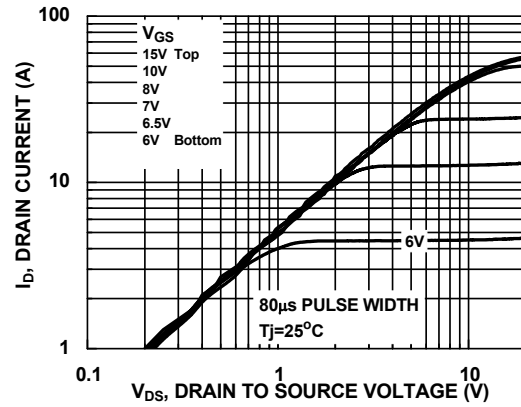


Figure 8. Saturation Characteristics

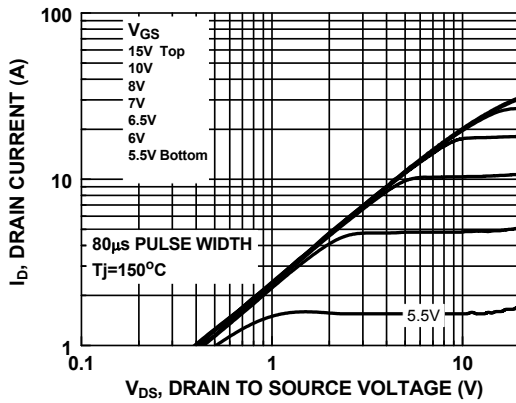


Figure 9. Saturation Characteristics

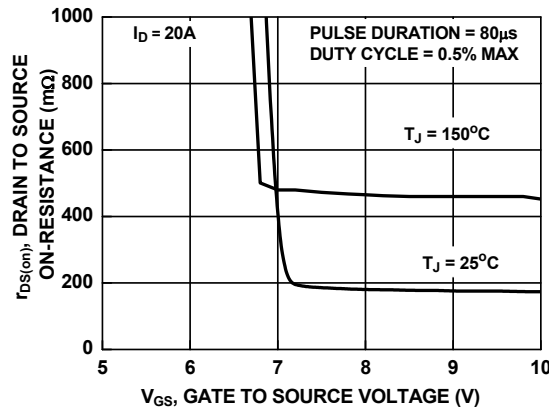


Figure 10. Rdson vs Gate Voltage

Typical Characteristics

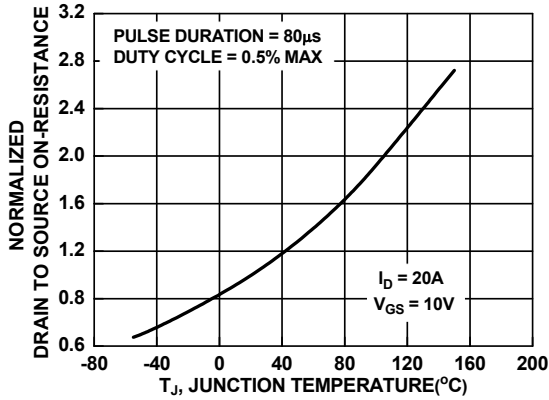


Figure 11. Normalized  $R_{DS(on)}$  vs Junction Temperature

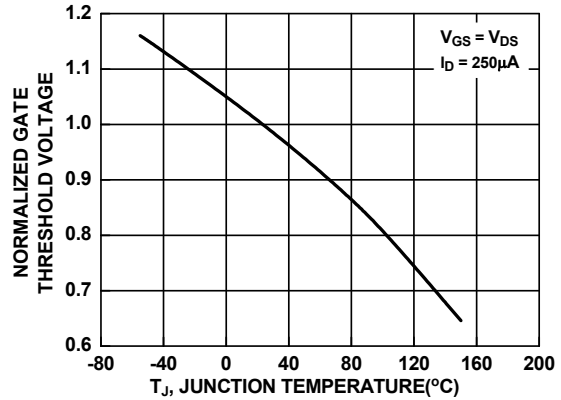


Figure 12. Normalized Gate Threshold Voltage vs Temperature

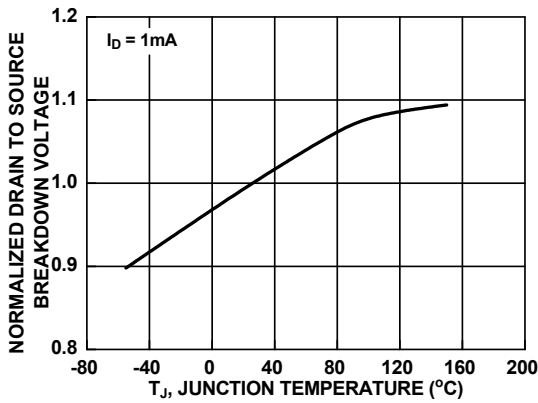


Figure 13. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

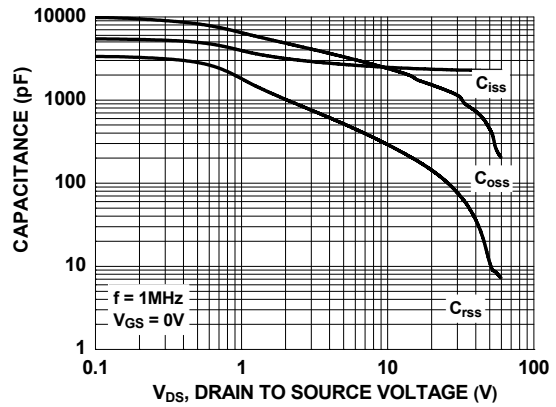


Figure 14. Capacitance vs Drain to Source Voltage

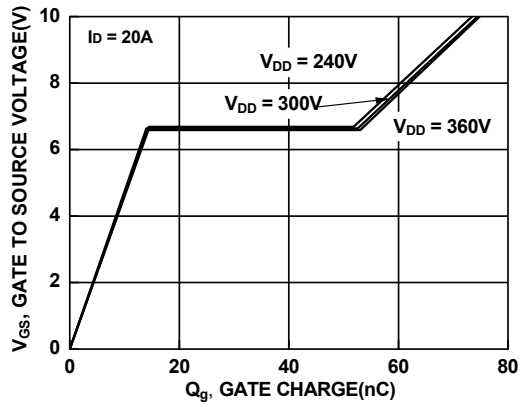




Figure 15. Gate Charge vs Gate to Source Voltage



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